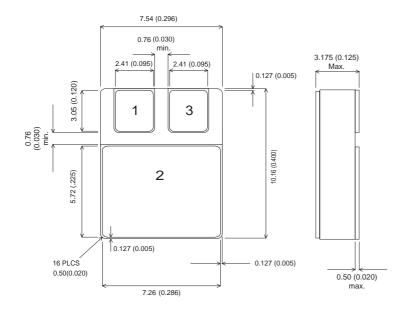




MECHANICAL DATA

Dimensions in mm (inches)



SMD05 (TO-276AA)

PAD1 = SOURCE PAD 2 = DRAIN PAD3 = GATE

P-CHANNEL **POWER MOSFET** FOR HI-REL **APPLICATIONS**

V_{DSS} -55V -22A I_{D(cont)} R_{DS(on)} 0.065Ω

FEATURES

- HERMETICALLY SEALED
- SIMPLE DRIVE REQUIREMENTS
- LIGHTWEIGHT
- SCREENING OPTIONS AVAILABLE

ABSOLUTE MAXIMUM RATINGS (T_{case} = 25°C unless otherwise stated)

V_{GS}	Gate – Source Voltage	±20V
I_D	Continuous Drain Current @ T _{case} = 25°C	-22A
I_D	Continuous Drain Current @ T _{case} = 100°C	-16A
I_{DM}	Pulsed Drain Current	-88A
P_{D}	Power Dissipation @ T _{case} = 25°C	75W
	Linear Derating Factor	0.6W/°C
T_J , T_stg	Operating and Storage Temperature Range	−55 to 150°C
$R_{\theta JC}$	Thermal Resistance Junction to Case	1.67°C/W max.

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ELECTRICAL CHARACTERISTICS ($T_C = 25$ °C unless otherwise stated)

	Parameter		Test Conditions		Тур.	Max.	Unit		
	STATIC ELECTRICAL RATINGS	•		•			•		
BV _{DSS}	Drain – Source Breakdown Voltage	$V_{GS} = 0$	I _D = -250μA	-55			V		
ΔBV_{DSS}	Temperature Coefficient of	Reference to 25°C			-0.049		V/°C		
ΔT_{J}	Breakdown Voltage	$I_D = -1mA$			-0.049				
R _{DS(on)}	Static Drain – Source On–State Resistance	V _{GS} = -10V	I _D = -16A			0.065	Ω		
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$	I _D = -250μA	-2		-4	V		
g _{fs}	Forward Transconductance	V _{DS} ≥ -25V	I _{DS} = -6A	8			S(Ω)		
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -55V				-25			
	$(V_{GS} = 0)$	V _{DS} = -44V	T _J = 125°C			-250	μΑ		
I _{GSS}	Forward Gate – Source Leakage	V _{GS} = -20V				-100			
I _{GSS}	Reverse Gate – Source Leakage	$V_{GS} = 20V$				100	mA		
	DYNAMIC CHARACTERISTICS								
C _{iss}	Input Capacitance	$V_{GS} = 0$			1290				
C _{oss}	Output Capacitance	V _{DS} = -25V			495		pF		
C _{rss}	Reverse Transfer Capacitance	f = 1MHz			203		1		
Qg	Total Gate Charge	V _{GS} = -10V				70			
Q _{gs}	Gate – Source Charge	V _{DS} = -44V				17	nC		
Q _{gd}	Gate – Drain ("Miller") Charge	I _D = -16A				30			
t _{d(on)}	Turn-On Delay Time	V _{DD} = -28V				26			
t _r	Rise Time	$I_D = -16A$ $R_G = 6.8\Omega$				125	ns		
t _{d(off)}	Turn-Off Delay Time					56			
t _f	Fall Time					74			
	SOURCE – DRAIN DIODE CHARAC	TERISTICS		•			•		
I _S	Continuous Source Current					-22*	А		
I _{SM}	Pulse Source Current					-88			
V _{SD}	Diode Forward Voltage	$I_S = -16A$ $V_{GS} = 0$	T _J = 25°C			-1.3	V		
t _{rr}	Reverse Recovery Time	I _S = -16A	$T_J = 25^{\circ}C$			100	ns		
Q _{rr}	Reverse Recovery Charge	$d_i / d_t \le -100A$	/μs V _{DD} ≤ -30V			250	nC		
					l				

^{*} Current Limited by package

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